Product data sheet

1. General description

The 74LV03 is a quad 2-input NAND gate with open-drain outputs. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess V_{CC} .

2. Features and benefits

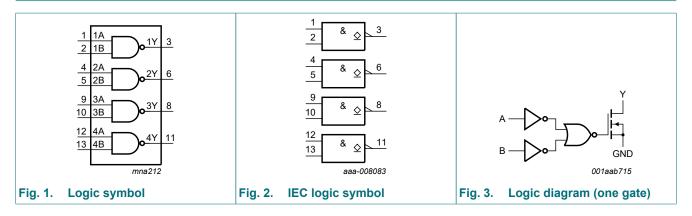
- Wide supply voltage range from 1.0 V to 5.5 V
- CMOS low power dissipation
- · Direct interface with TTL levels
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LV03D	-40 °C to + 125 °C		plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1

4. Functional diagram

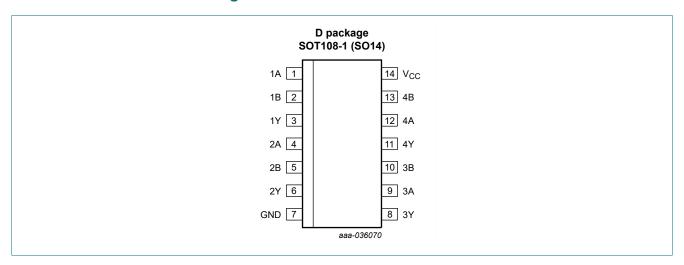




Quad 2-input NAND gate

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A, 2A, 3A, 4A	1, 4, 9, 12	data input
1B, 2B, 3B, 4B	2, 5, 10, 13	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; Z = high-impedance OFF-state.}$

Input	Output	
nA	nB	nY
L	L	Z
L	Н	Z
Н	L	Z
Н	Н	L

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±50	mA
lo	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ [2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	[1]	1.0	3.3	5.5	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.0 V to 2.0 V	-	-	500	ns/V
		V _{CC} = 2.0 V to 2.7 V	-	-	200	ns/V
		V _{CC} = 2.7 V to 3.6 V	-	-	100	ns/V
		V _{CC} = 3.6 V to 5.5 V	-	-	50	ns/V

^[1] The static characteristics are guaranteed from V_{CC} = 1.2 V to V_{CC} = 5.5 V, but LV devices are guaranteed to function down to V_{CC} = 1.0 V (with input levels GND or V_{CC}).

^[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.

Quad 2-input NAND gate

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	-40 °C to +85 °C			-40 °C to +125 °C	
			Min	Typ [1]	Max	Min	Max	1
V _{IH}	HIGH-level	V _{CC} = 1.2 V	0.9	-	-	0.9	-	V
	input voltage	V _{CC} = 2.0 V	1.4	-	-	1.4	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	0.7 × V _{CC}	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.3	-	0.3	V
	input voltage	V _{CC} = 2.0 V	-	-	0.6	-	0.6	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	-	0.3 × V _{CC}	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}						
	output voltage	I _O = 100 μA; V _{CC} = 1.2 V	-	0	-	-	-	V
		I _O = 100 μA; V _{CC} = 2.0 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 2.7 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 3.0 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 4.5 V	-	0	0.2	-	0.2	V
		I _O = 6 mA; V _{CC} = 3.0 V	-	0.25	0.40	-	0.50	V
		I _O = 12 mA; V _{CC} = 4.5 V	-	0.35	0.55	-	0.65	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	1.0	μΑ
l _{OZ}	OFF-state output current	per input pin; V_{CC} = 2.0 V to 3.6 V; V_I = V_{IL} ; V_O = V_{CC} or GND; other inputs at V_{CC} or GND	-	-	±5.0	-	±10	μA
		per input pin; V_{CC} = 2.0 V to 3.6 V; V_I = V_{IL} ; V_O = 6.0 V; other inputs at V_{CC} or GND	[2] -	-	±10.0	-	±20	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	20.0	-	40	μΑ
ΔI _{CC}	additional supply current	per input; $V_I = V_{CC} - 0.6 \text{ V};$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	500	-	850	μΑ
Cı	input capacitance		-	3.5	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C. [2] The maximum operating output voltage ($V_{O(max)}$) is 6.0 V.

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Quad 2-input NAND gate

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; For test circuit see Fig. 5.

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	
t _{pd}	propagation	nA, nB to nY; see Fig. 4 [2]						
	delay	V _{CC} = 1.2 V	-	50	-	-	-	ns
		V _{CC} = 2.0 V	-	17	26	-	31	ns
		V _{CC} = 2.7 V	-	13	19	-	23	ns
		V _{CC} = 3.3 V; C _L = 15 pF	-	8	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V [3]	-	10	16	-	19	ns
		V _{CC} = 4.5 V to 5.5 V	-	-	13	-	16	ns
C _{PD}	power dissipation capacitance	$C_L = 0 \text{ pF}; R_L = \infty \Omega;$ [4] $V_I = \text{GND to } V_{CC}$	-	4	-	-	-	pF

- All typical values are measured at T_{amb} = 25 °C.
- t_{pd} is the same as t_{pLZ} and t_{pZL} . Typical values are measured at nominal supply voltage ($V_{CC} = 3.3 \text{ V}$). [3]
- C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

f_i = input frequency in MHz,

fo = output frequency in MHz

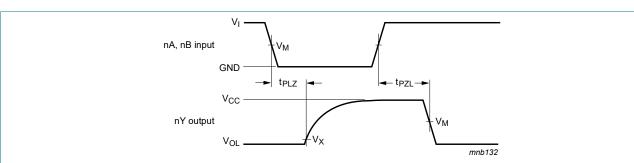
C_L = output load capacitance in pF

V_{CC} = supply voltage in V

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

10.1. Waveforms and test circuit



Measurement points are given in Table 8

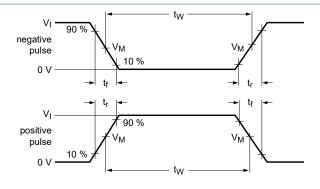
V_{OL} is a typical voltage output level that occurs with the output load.

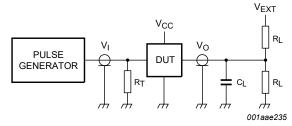
Inputs nA and nB to output nY propagation delay times

Table 8. Measurement points

Supply voltage	Input	Output		
V _{CC}	V _M	V _X	V _M	
≤ 2.7 V	0.5 × V _{CC}	V _{OL} + 0.1 V	0.5 × V _{CC}	
2.7 V to 3.6 V	1.5 V	V _{OL} + 0.3 V	1.5 V	
≥ 4.5 V	0.5 × V _{CC}	V _{OL} + 0.1 V	0.5 × V _{CC}	

Quad 2-input NAND gate





Test data is given in Table 9

Definitions for test circuit:

R_L = Load resistance;

C_L = Load capacitance including jig and probe capacitance;

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator;

 V_{EXT} = External voltage for measuring switching times.

Fig. 5. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load		V _{EXT}
V _{CC}	V _I	t _r , t _f	CL	R _L	t _{PLZ} , t _{PZL}
≤ 2.7 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	2 × V _{CC}
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	1 kΩ	2 × V _{CC}
≥ 4.5 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	2 × V _{CC}

Quad 2-input NAND gate

11. Package outline

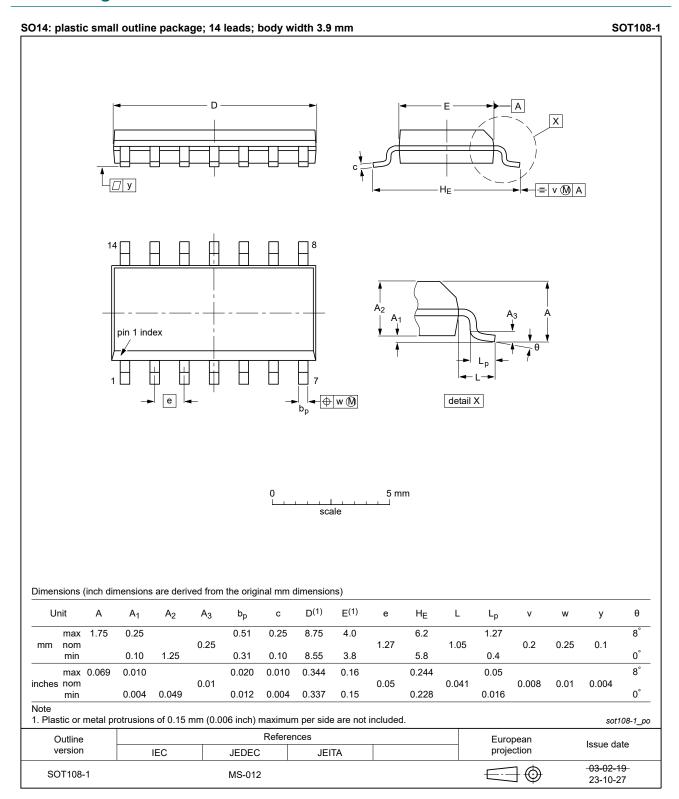


Fig. 6. Package outline SOT108-1 (SO14)

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12. Abbreviations

Table 10. Abbreviations

Acronym	Description	
CDM	Charged Device Model	
CMOS	mplementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	luman Body Model	
TTL	Transistor-Transistor Logic	

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LV03 v.5	20240122	Product data sheet	-	74LV03 v.4		
Modifications:	<u>Section 2</u>: E<u>Section 7</u>: E	 Section 1 and Section 2 updated. Section 2: ESD specification updated according to the latest JEDEC standard. Section 7: Derating values for P_{tot} total power dissipation updated. Fig. 6: Aligned SO package outline drawing to JEDEC MS-012 				
74LV03 v.4	20170831	Product data sheet	-	74LV03 v.3		
Modifications:	Nexperia.					
74LV03 v.3	20030303	Product data sheet	ECN 853-1963 29494	74LV03 v.2		
Modifications:	options).					
74LV03 v.2	19980420	Product specification	ECN 853-1963 19257	74LV03 v.1		
74LV03 v.1	19970328	Product specification	-	-		

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14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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